



Material Composition Sheet

Product: GS4910BCNE3
 Package Type: QFN-64 pin (260/tray)
 Manufacturer: Gennum Corporation

Date: 06-Dec-2006

Component	BOM	Weight of Component (mg)	Substance	Weight of Substance (mg)	Homogeneous Material	
					%	ppm
Die		7.79	Al	0.05	0.64	6418
			Si	7.74	99.35	993582
			Sub-total:	7.79	99.99	1000000
Die Attach	CRM 1076DS	1.18	Ag	0.90	76.27	762712
			Epoxy Resin	0.15	12.71	127119
			Epoxy Silane	0.01	0.84	8475
			Phenol Resin	0.03	2.54	25424
			t-Butylphenylglycidil ether	0.08	6.77	67797
			Sub-total:	1.17	99.13	991527
Internal Pad Plating		1.69	Ag	1.69	100.00	1000000
			Sub-total:	1.69	100.00	1000000
Leadframe	Olin 7025	117.14	Cu	112.69	96.20	962011
			Mg	0.18	0.15	1537
			Ni	3.51	2.99	29964
			Si	0.76	0.64	6488
			Sub-total:	117.14	99.98	1000000
Marking Ink		0.00		0.00	0.00	0
			Sub-total:	0.00	0.00	0
Mold Compound	EME G770HC	102.53	Carbon Black	0.51	0.49	4974
			Epoxy Resin A	4.61	4.49	44962
			Epoxy Resin B	4.61	4.49	44962
			Metal Hydroxide	2.05	1.99	19994
			Phenol Resin	4.61	4.49	44962
			SiO2	86.14	84.01	840144
			Sub-total:	102.53	99.96	999998
Terminals Finish		5.26	Sn	5.26	100.00	1000000
			Sub-total:	5.26	100.00	1000000
Wires	AW88	1.79	Au	1.79	100.00	1000000
			Sub-total:	1.79	100.00	1000000
Total:		237.38				

GENNUM CORPORATION

Mailing Address: P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3
 Shipping Address: 970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5
 Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

www.gennum.com

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